

NEW

InSPEC

Integrated SEM Metrology and Inspection

# InSPEC

SEM Metrology & Inspection Kit

*If you cannot measure it – you cannot improve it*



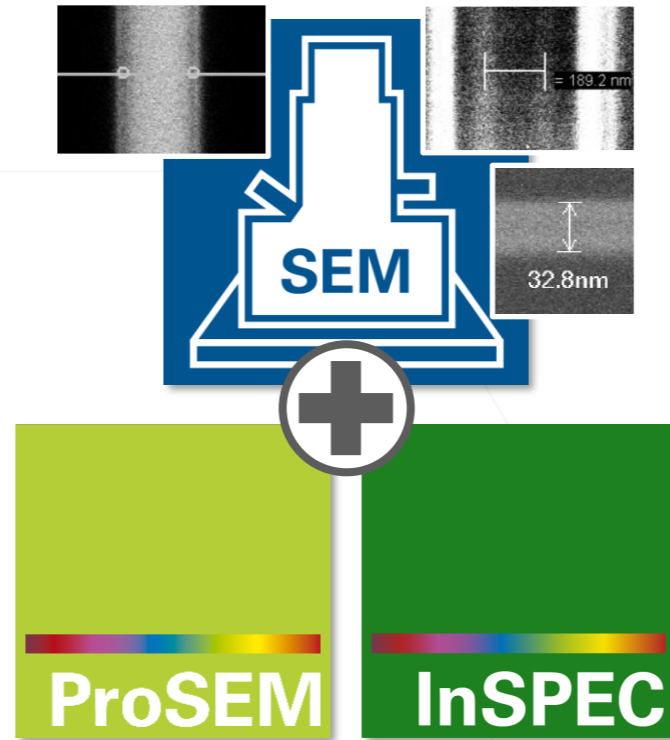
Lord Kelvin

# The Metrology Challenge

Various dedicated and optimized lithography tools



*Metrology with a versatile microscope...?*

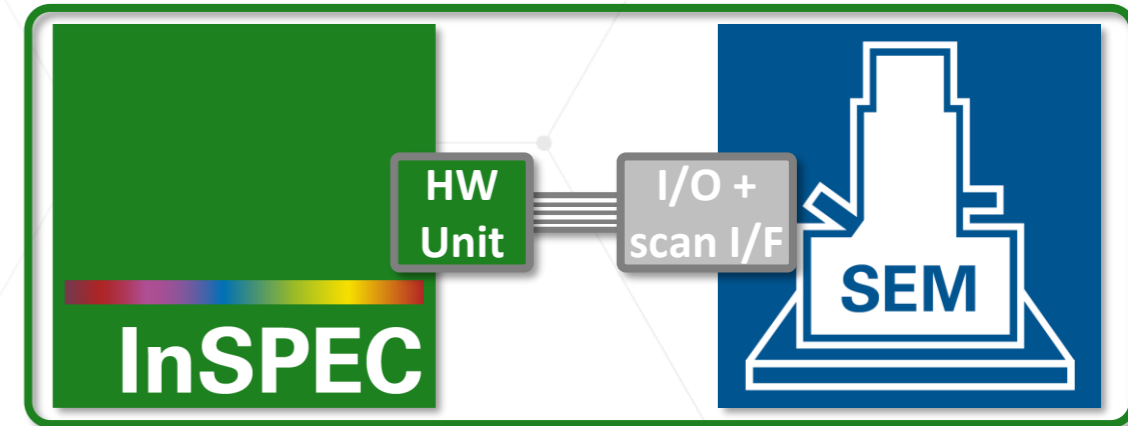


Specialized and fully automatic CD-SEM



# InSPEC Upgrade Kit

→ Upgrade your versatile microscope to an integrated “Metrology & Inspection SEM”



Upgrade Kit for a Metrology SEM

Integrated scanning, automation & metrology

Direct SEM control with hardware integration

Multi-Chip jobs with hierarchical structure

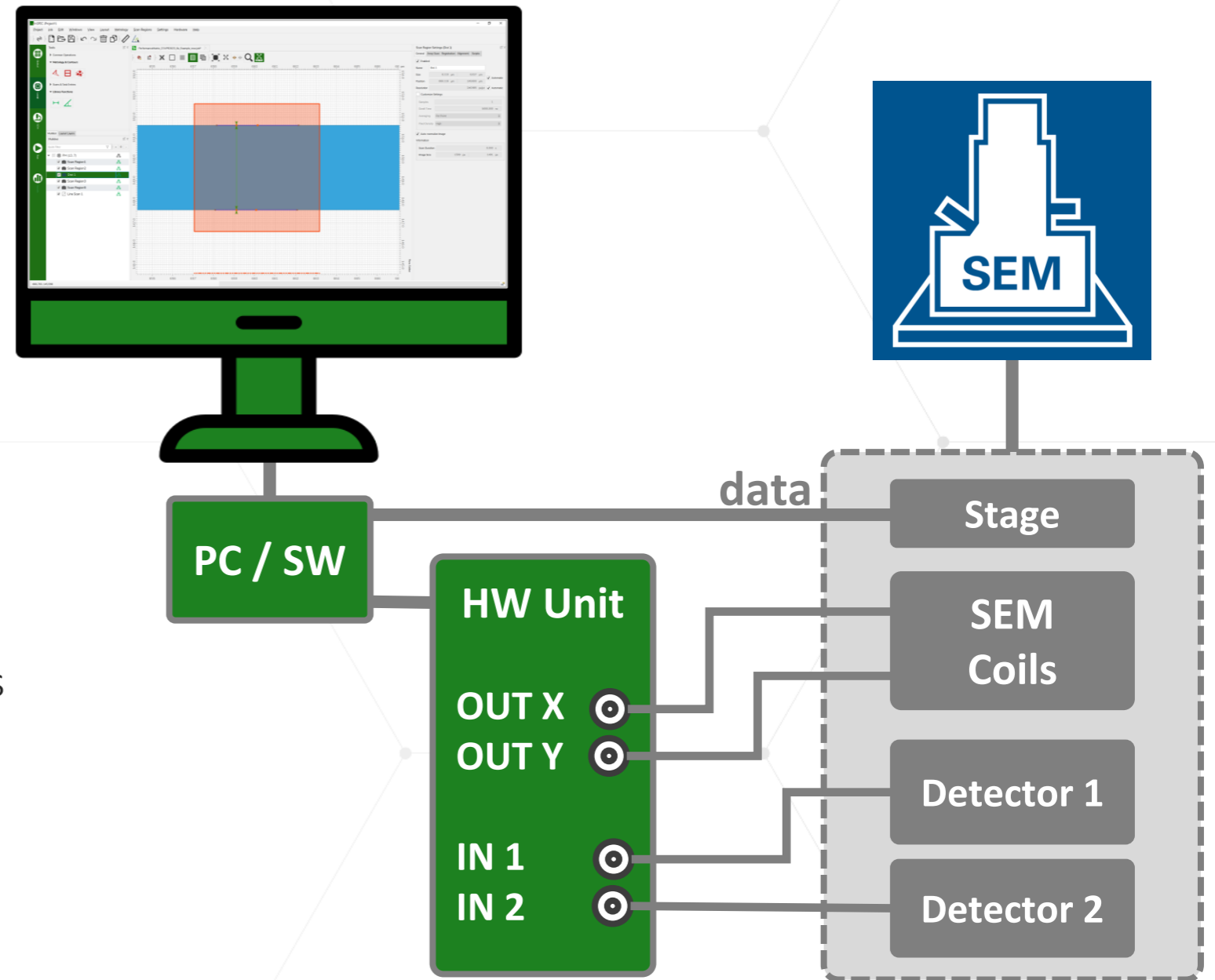
Comprehensive full layout-based workflow

Expert metrology & data processing with “FLOW”

## Integrated Upgrade Kit

- Software package
- PC and screen
- Scanning and I/O hardware

- Direct control of SEM beam, stage, scanning
- Use the designed I/F and safety mechanisms
- All beam shaping settings
- Scanning and tool operation through InSPEC



# Integrated Workflow along 5 Main Modes

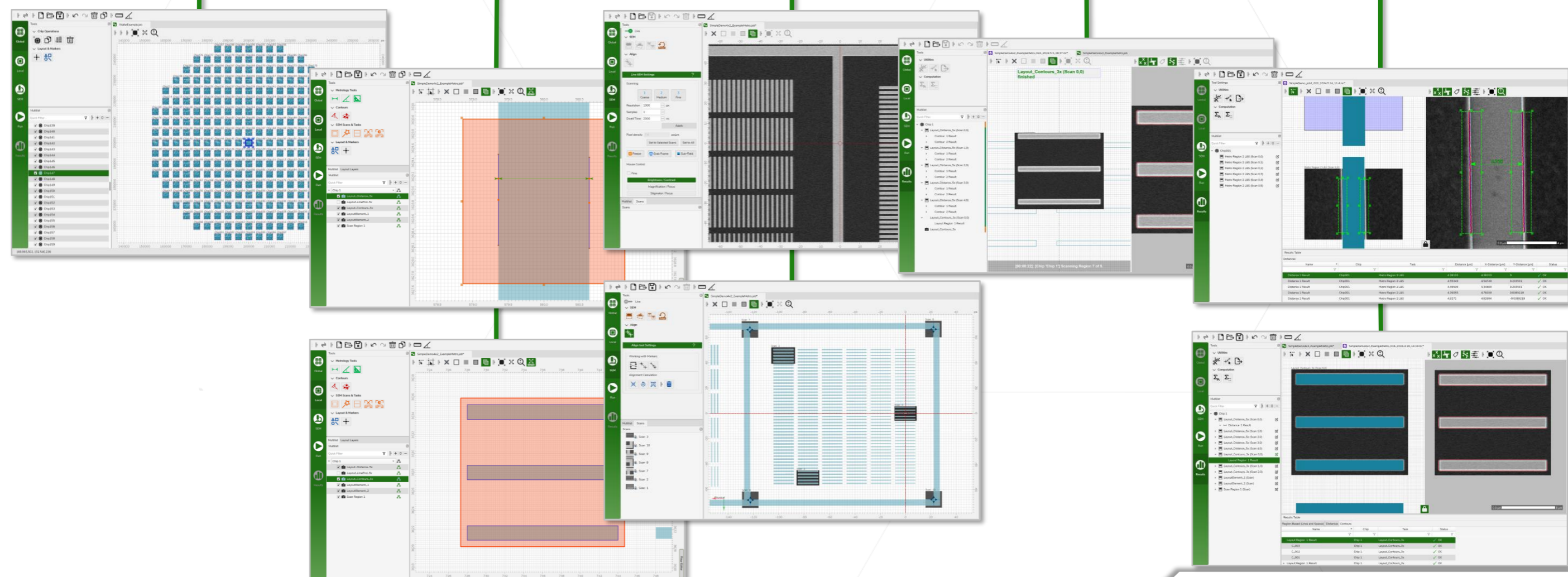
 Global

 Local

 SEM

 Run

 Results



The collage illustrates the integrated workflow through five main modes:

- Global:** Shows a top-level layout of a chip with a grid of blue squares representing scan regions.
- Local:** Provides a zoomed-in view of a specific area, highlighting a rectangular region in orange.
- SEM:** Displays SEM scan parameters such as Resolution (2000), Sample Size (2000), and Drift Time (2000).
- Run:** Shows the execution of a scan, with a progress bar and a 'Finished' status for 'Layout\_Contours\_3x (Scan 0.0)'.
- Results:** Displays the results of the scan, including a table of distances and a visual representation of the contours.

Distance 1 Result	Name	Chip	Task	Distance [µm]	X-Offset [µm]	Y-Offset [µm]	Status
Distance 1 Result	Chip01	Chip01	Layout_Contours_3x	4.81045	0.00000	0.00000	OK
Distance 2 Result	Chip01	Layout_Contours_3x	4.49308	0.00000	0.00000	OK	
Distance 3 Result	Chip01	Layout_Contours_3x	4.80000	0.00000	0.00000	OK	
Distance 4 Result	Chip01	Layout_Contours_3x	4.82711	0.00000	0.00000	OK	

## 5 Main modes with adaptive panels

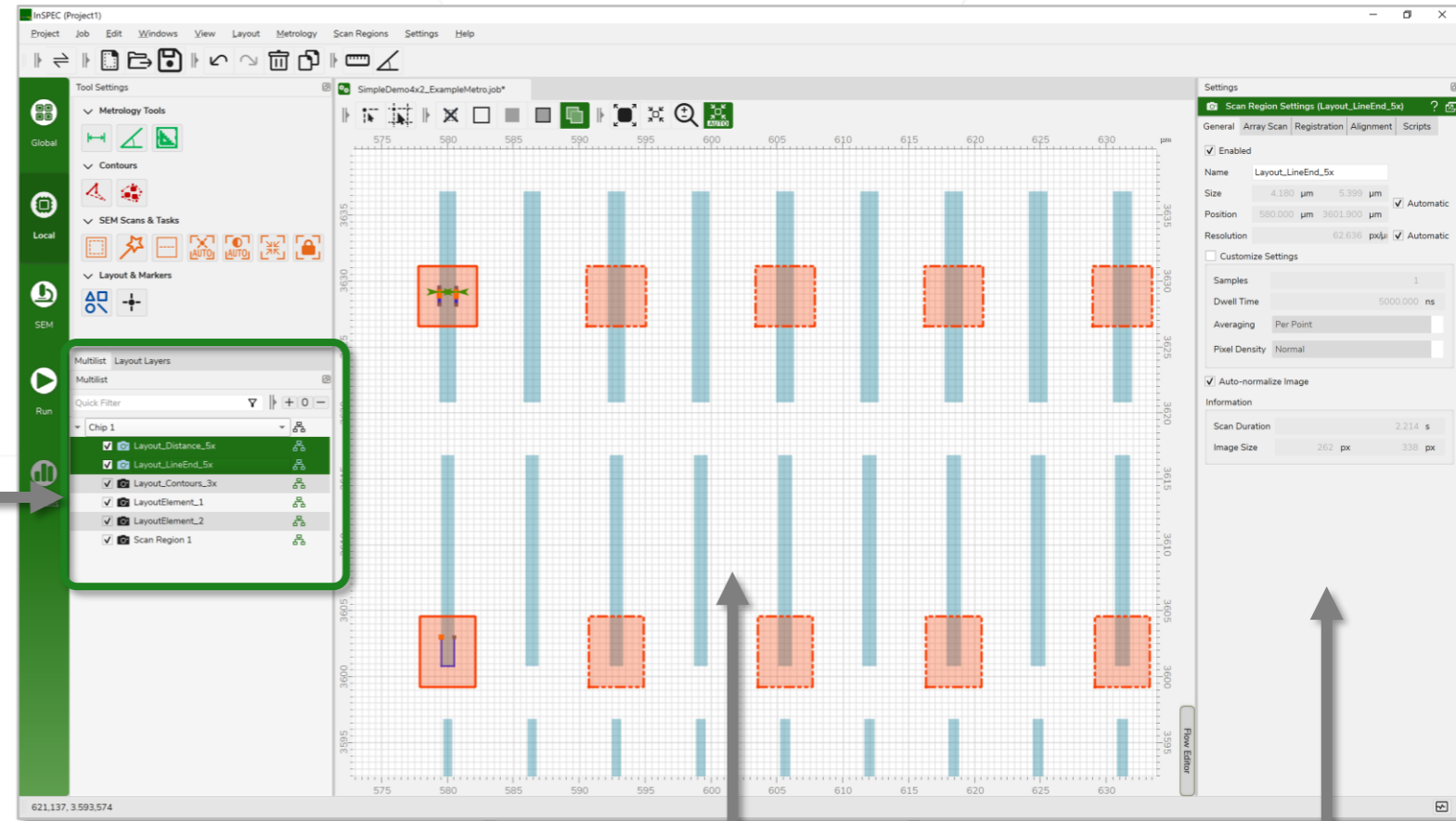
- Global/ local definition of metrology job
- SEM control “live” and layout-based
- Run job: parallel scanning, metrology, analysis
- Results review and further processing

## Job sequence

- Smart and simplified metrology job
- Project with multiple jobs/ multiple result files

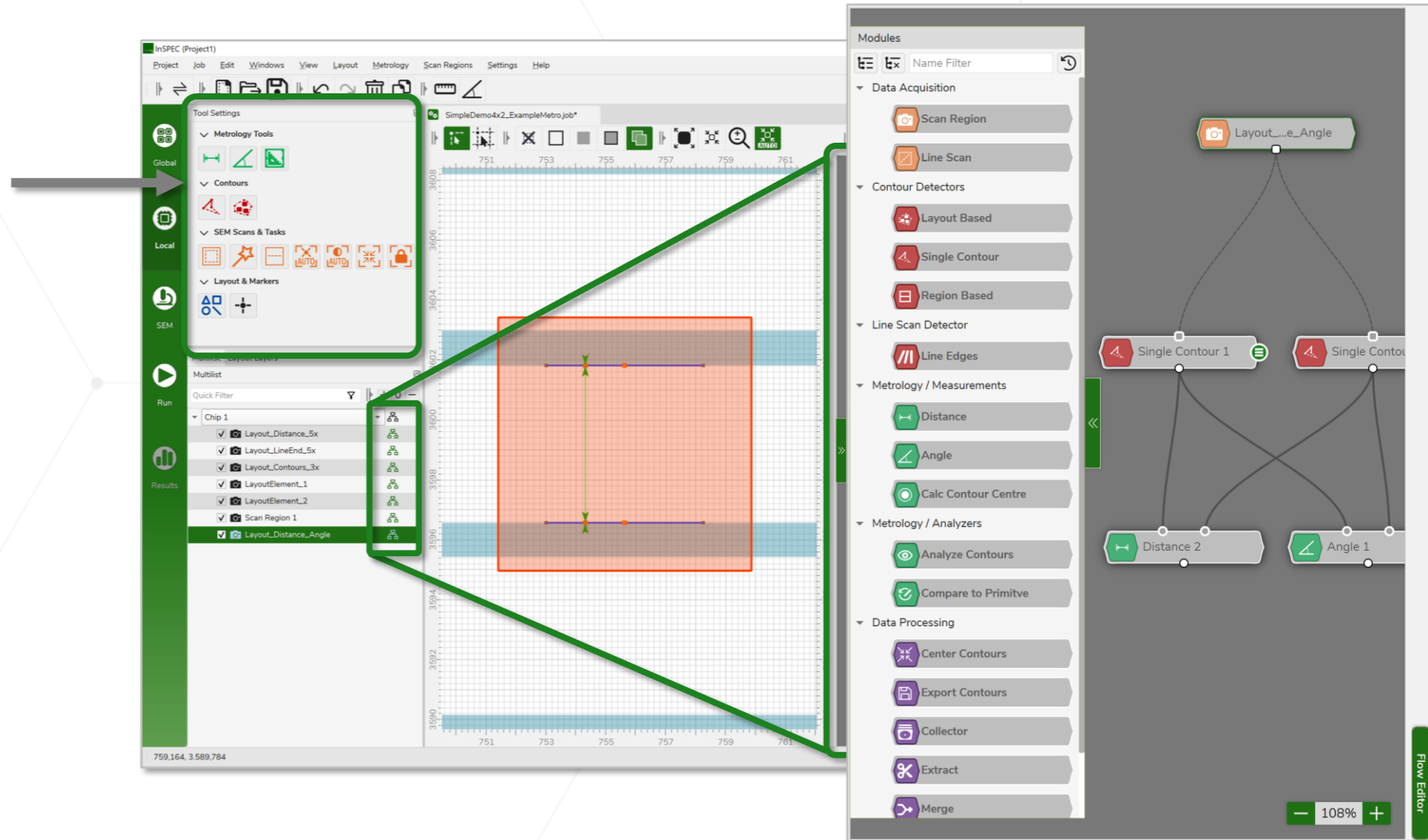
## Working area and details

- Center visual area with layout
  - Can split for layout view & FLOW editor
- Right: details and advanced settings

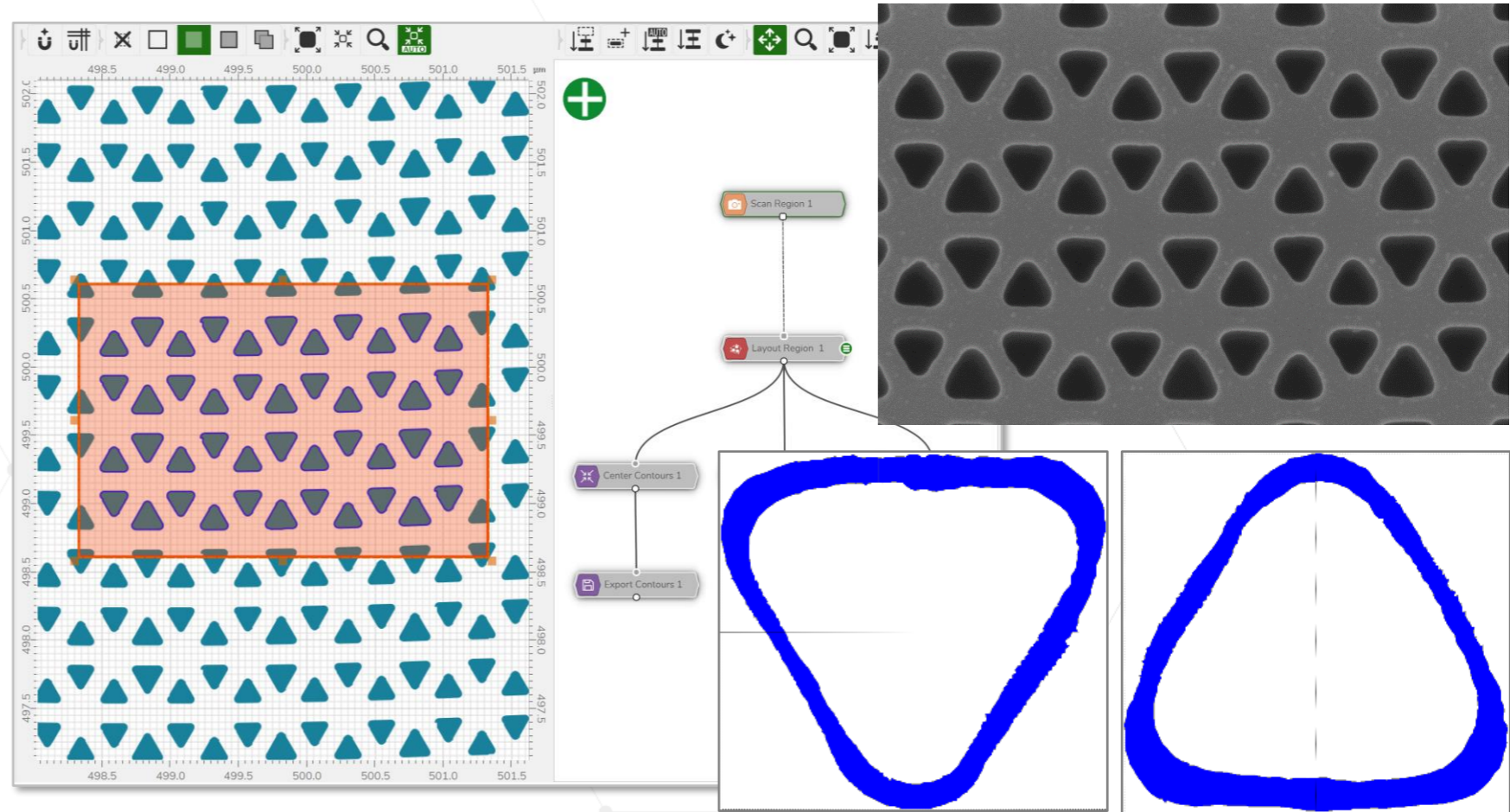




- FLOW structure and editor
  - Basis for standard tools with pre-defined functionality
  - FLOW contains all methods for obtaining metrology results
  - Modules for
    - Scanning (region, line)
    - Edge/ contour detection
    - Metrology & analysis
    - Data processing
  - Enables complex tasks without programming/ scripting
  - Create personal templates



- FLOW editor
  - FLOW contains all methods for obtaining metrology results
  - Modules for
    - Scanning (region, line)
    - Edge/ contour detection
    - Metrology & analysis
    - Data processing
- Example (PSU)
  - SEM scanning region
  - Multiple contour extraction
  - Compare to triangle and layout
  - PV band creation/ export (process variation)



# Global Setup and (Wafer) Arrangement

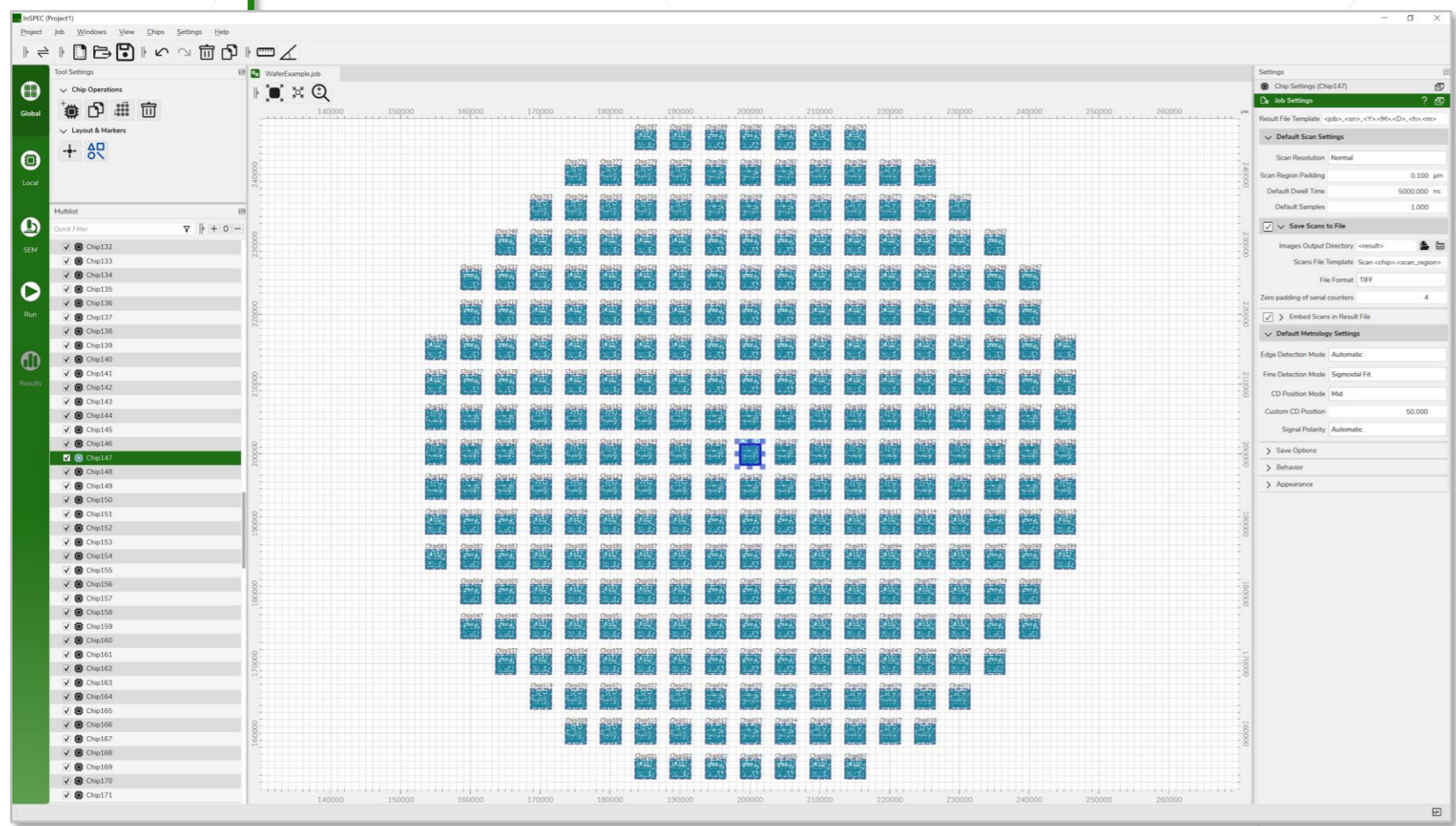
 **Global**

 **Local**

 **SEM**

 **Run**

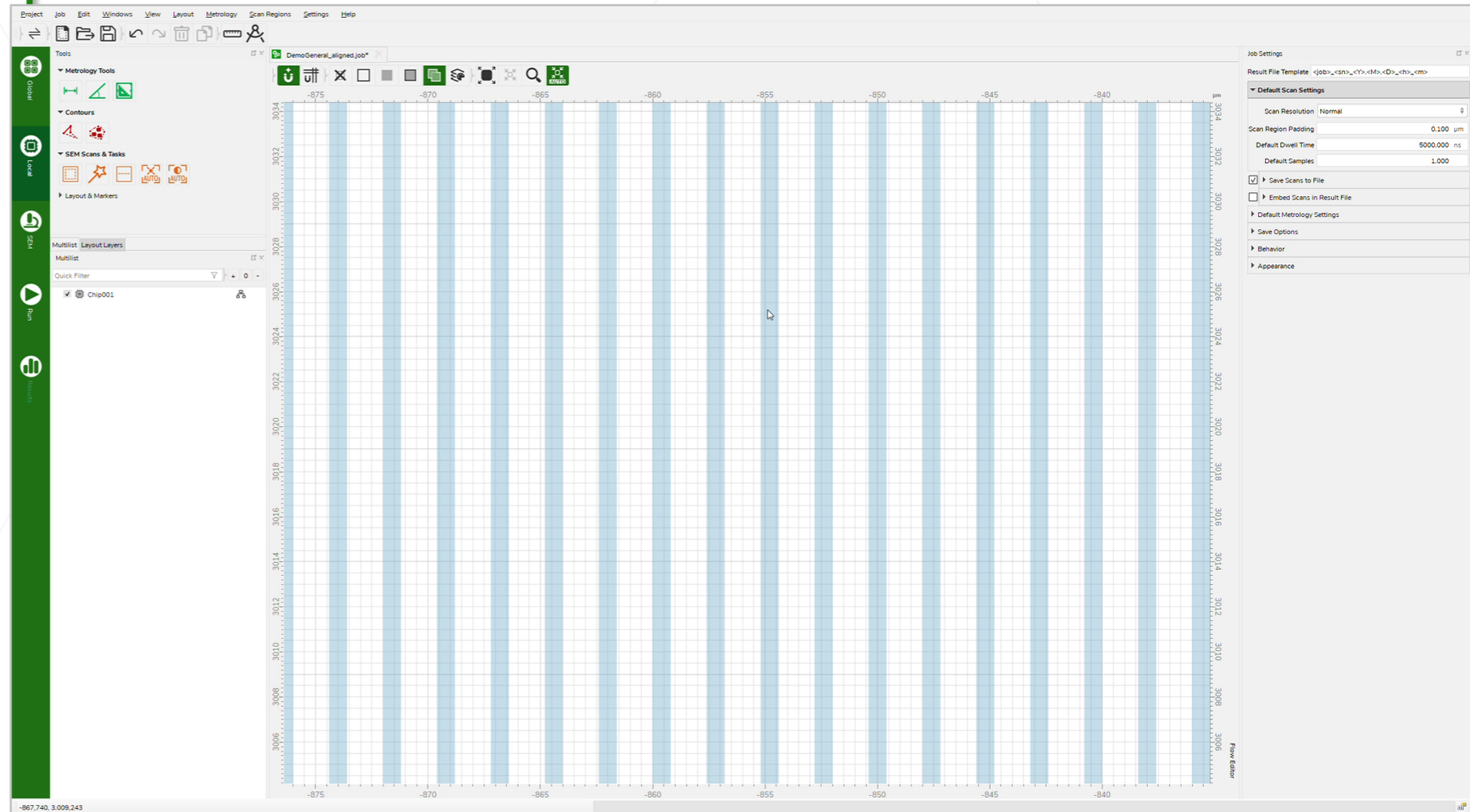
 **Results**



- General sample/ job arrangement
  - Chips/ field size and position
  - Matrix setups
  - Enable/ disable chips/ fields
  - Reference layout(s)



- Chip/ field level
  - Metrology based on layout
    - Automatic scan definition
  - SEM scans (region, line)
- Job list can contain
  - Scans
  - Scans and contour
  - Scans and metrology
  - Plus data processing
  - Focusing/ alignments



# „Layout-less“ based on Metrology Region

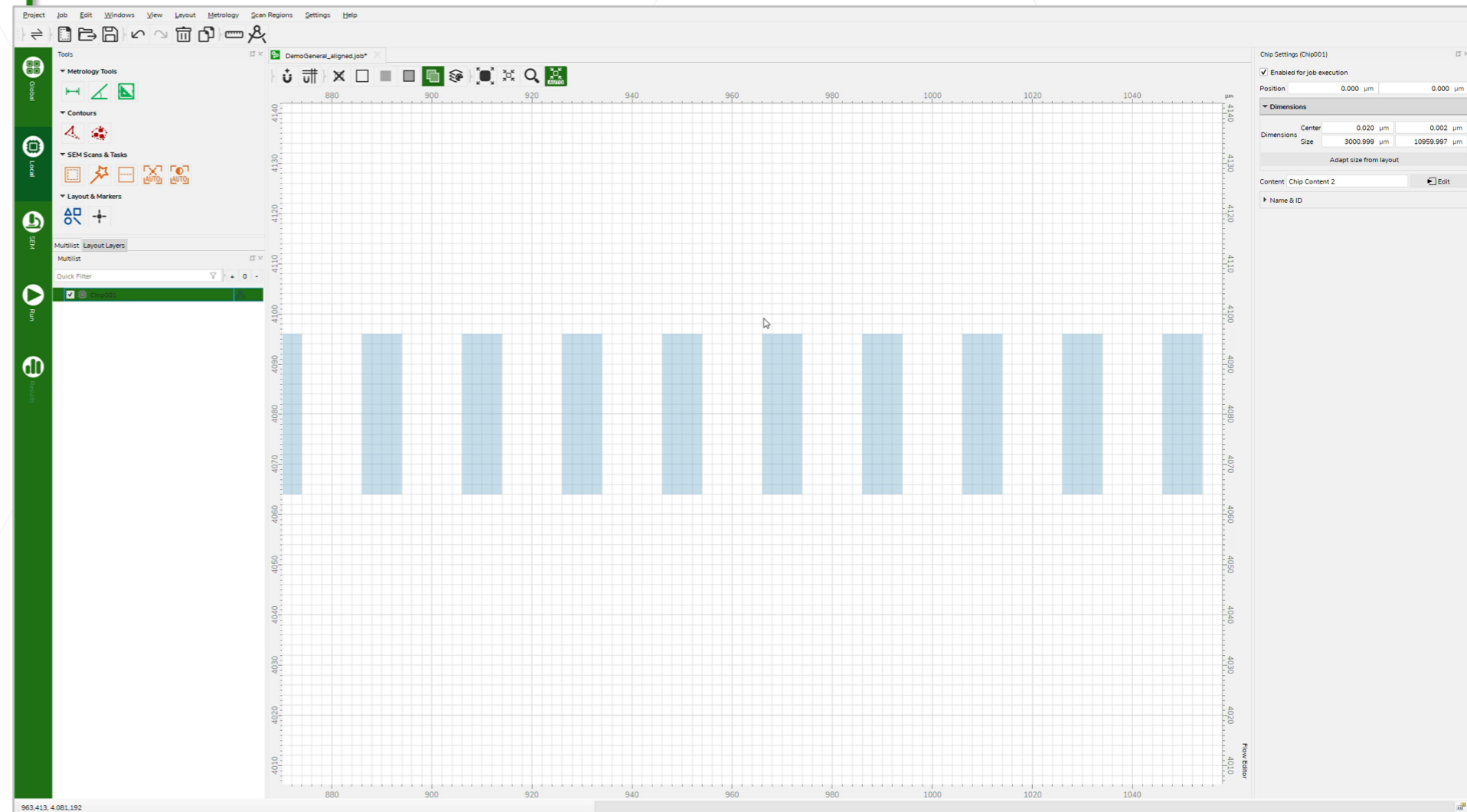


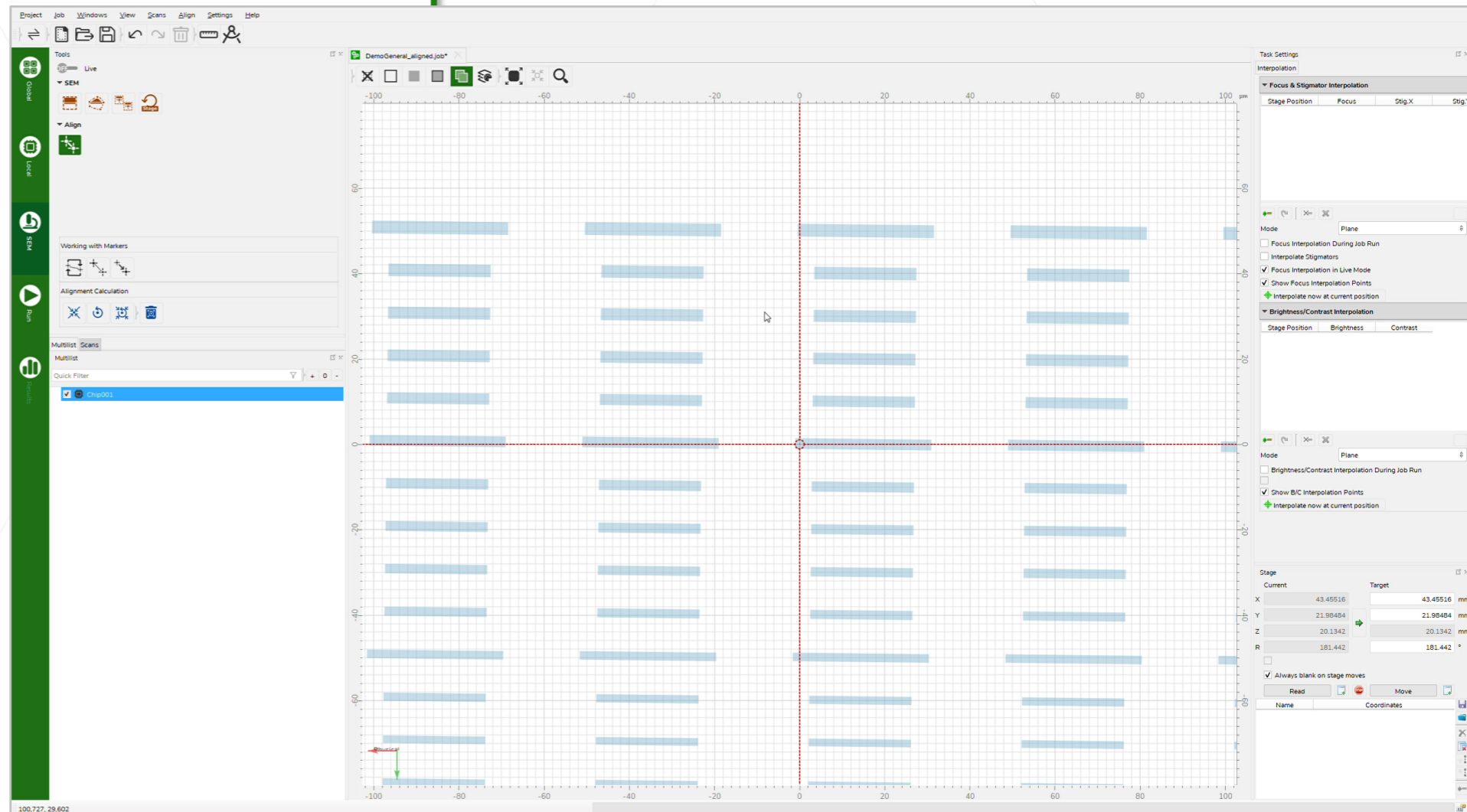
## • Use case

- No (full) layout available
- No good representation
- Strong process bias

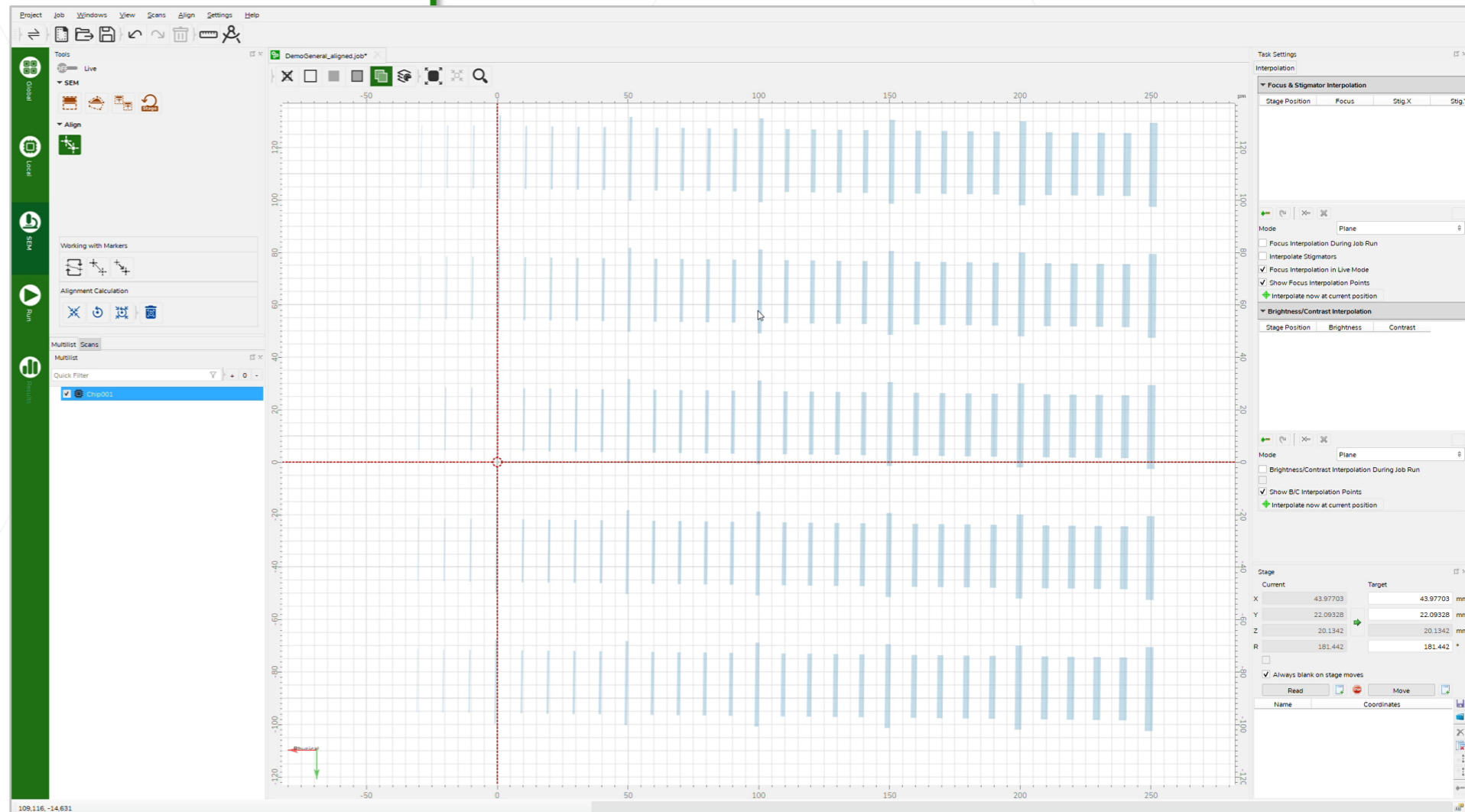
## • Metrology region

- Layout only as background
- No comparison with layout
- Provides contours
- Fitting with primitives





- SEM beam/ image control
  - Preset scan speeds
  - Control of beam shaping
    - Contrast/ brightness
    - Magnification/ focus
    - Stigmation/ focus
  - Stage control



- SEM work with Layout
  - Alignment via markers
  - SEM scans interactively
  - Scans in list and shown on layout
  - Navigation and positions
  - Focus points and mapping
    - Working distance
    - Stigmator X/Y
    - Contrast/ brightness

# Run the Metrology Job



Global



Local



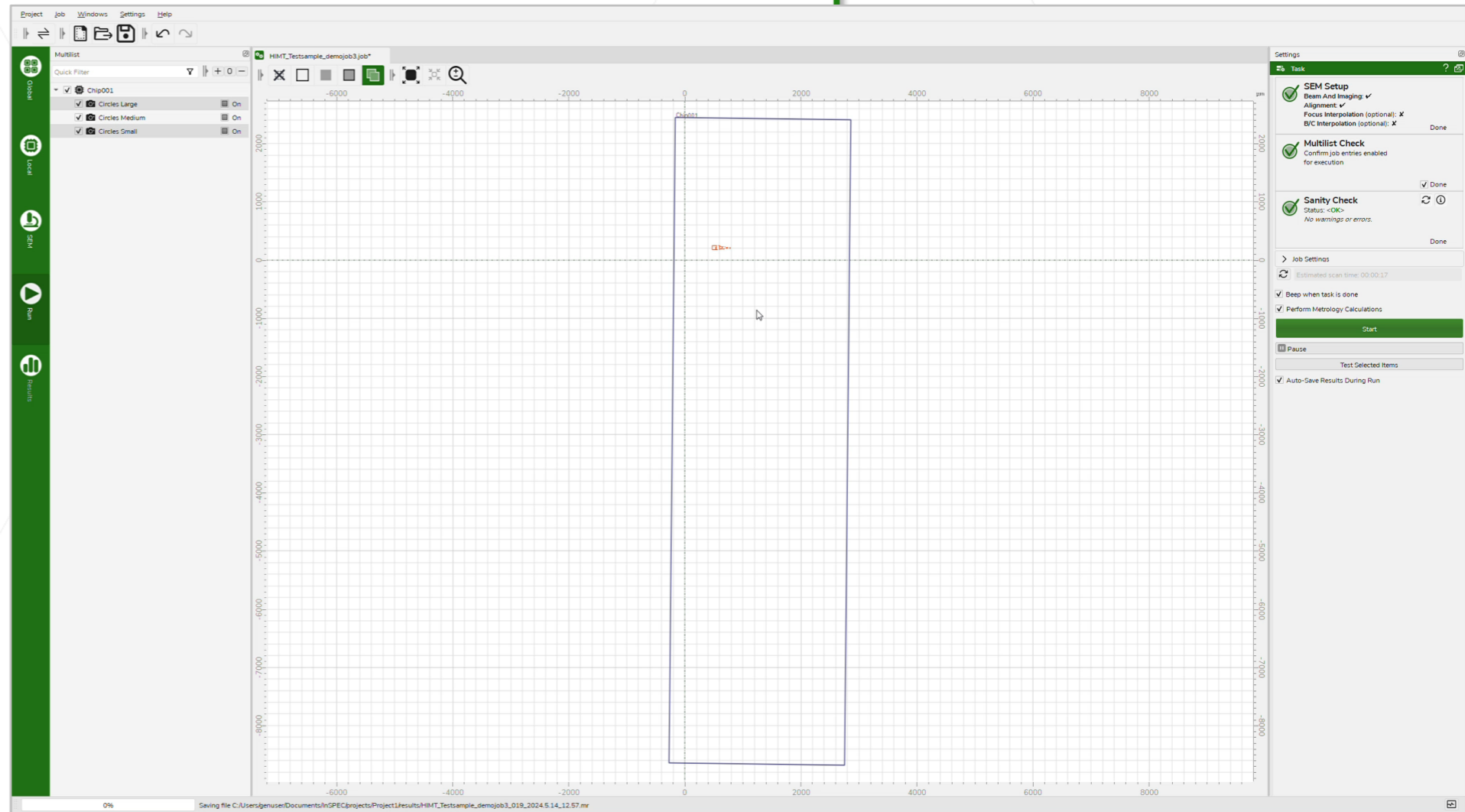
SEM



Run



Results



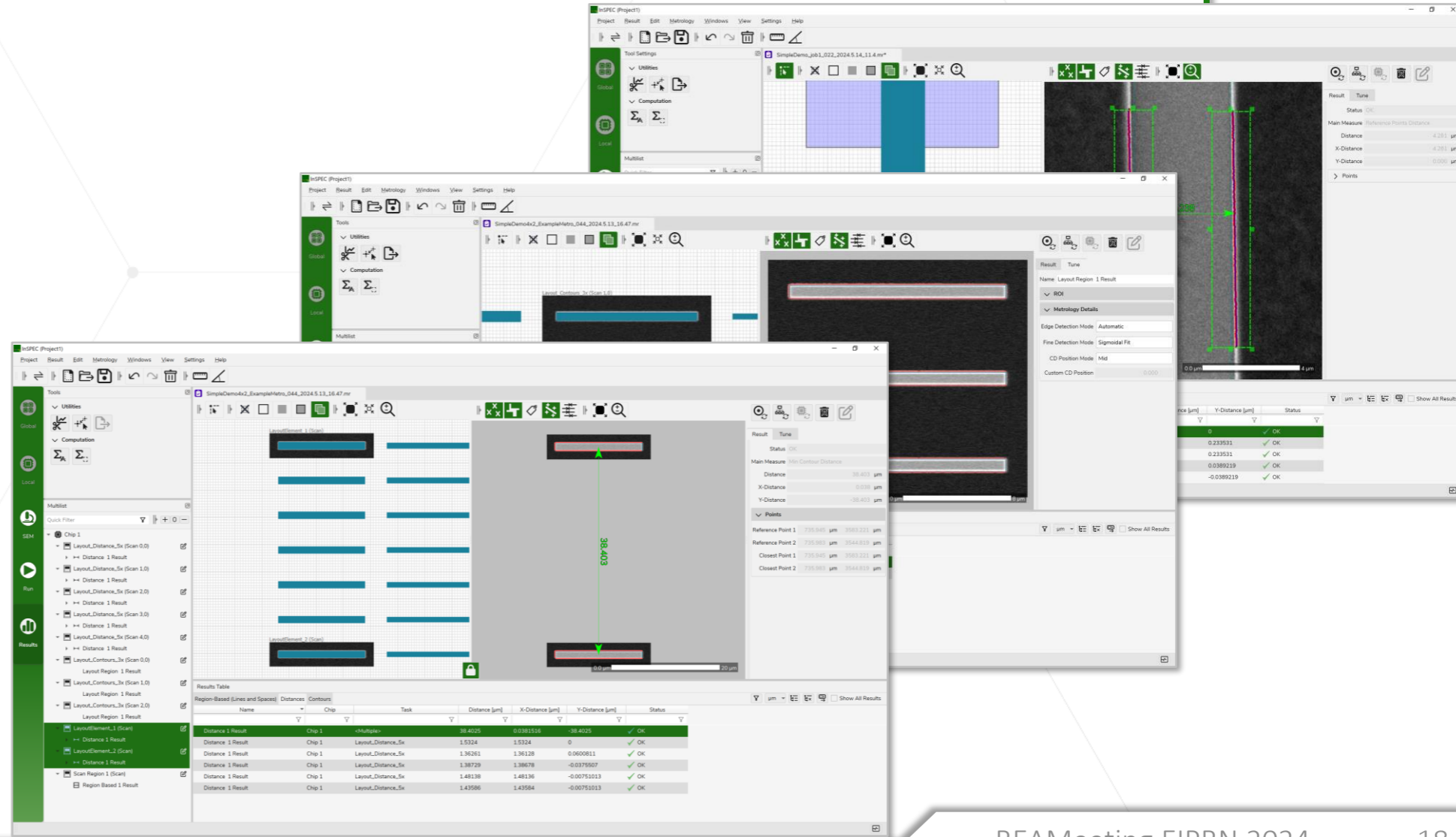
- Job execution

- Job start and pause/ stop
- Progress of job sequence
- Live scans on layout
- Parallel activities
  - Scanning
  - Corrections
  - Contour detection
  - Metrology
  - Data processing
- Creates results file





- Results summary
  - Job list including results
  - Display
    - Layout with definitions
    - Scan with metrology
  - Results tables with tabs
  - Details review/ tuning



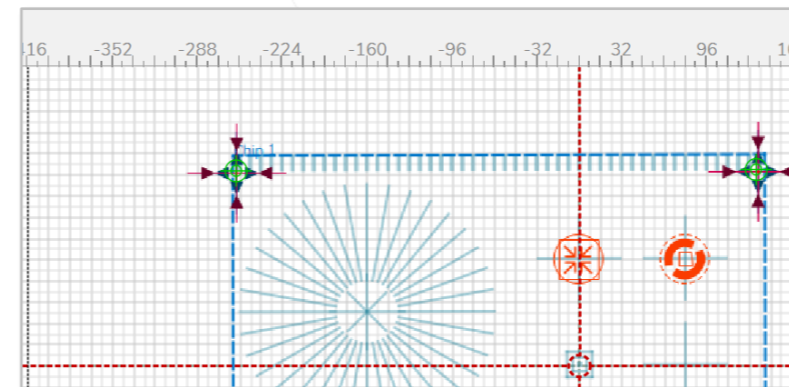
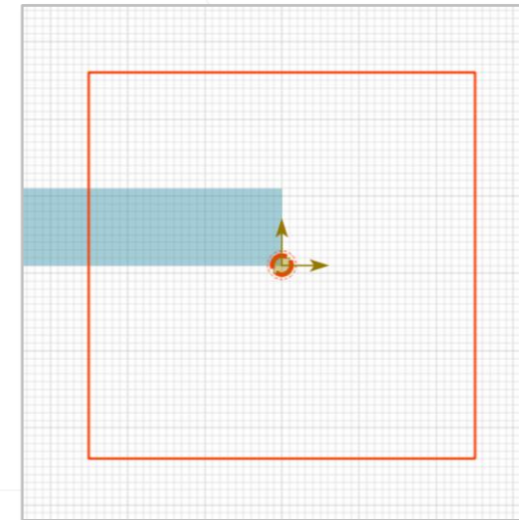
The screenshot displays the GenISys software interface. The sidebar on the left contains icons for Global, Local, SEM, Run, and Results. The main workspace shows a grid with measurement tools and a results table at the bottom. The results table is as follows:

Region-Based (Lines and Spaces)	Distances	Contours	Name	Chip	Task	Distance [µm]	X-Distance [µm]	Y-Distance [µm]	Status
			Distance 1 Result	Chip 1	Layout_Distance_Sx	38.4025	0.03815516	-38.4025	OK
			Distance 1 Result	Chip 1	Layout_Distance_Sx	1.5324	1.5324	0	OK
			Distance 1 Result	Chip 1	Layout_Distance_Sx	1.36261	1.36128	0.0000811	OK
			Distance 1 Result	Chip 1	Layout_Distance_Sx	1.38729	1.38678	-0.0375507	OK
			Distance 1 Result	Chip 1	Layout_Distance_Sx	1.48138	1.48136	-0.00751013	OK
			Distance 1 Result	Chip 1	Layout_Distance_Sx	1.43586	1.43584	-0.00751013	OK

# Addressing SEM Challenges 1: Focus

Sample tilt and bow require focus correction

- Automatic focusing
  - Integrated auto focus functionality for job sequence
  - Scanning large-to-small with focusing coarse-to-fine
- Focus correction points and map
  - Linear interpolation or non-linear corrections
  - Many points, optionally including stigmator



▼ Focus & Stigmator Interpolation

Stage Position	Focus	Stig.X	Stig.Y
41.7482, 33.5086 ...	39.86664	0.09	0.12
42.5525, 33.5931 ...	39.85911	0.09	0.12
42.5975, 34.7664 ...	39.85623	0.10	0.13
41.7927, 34.7634 ...	39.84910	0.11	0.14
42.5289, 36.8665 ...	39.85118	0.11	0.14
41.7264, 36.8639 ...	39.87932	0.11	0.14

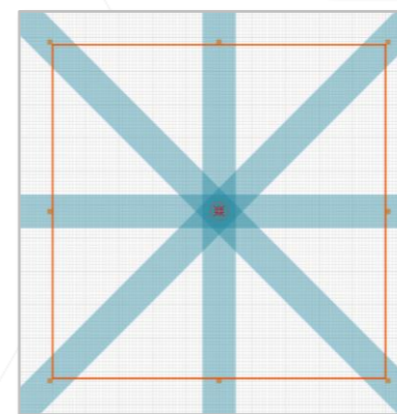
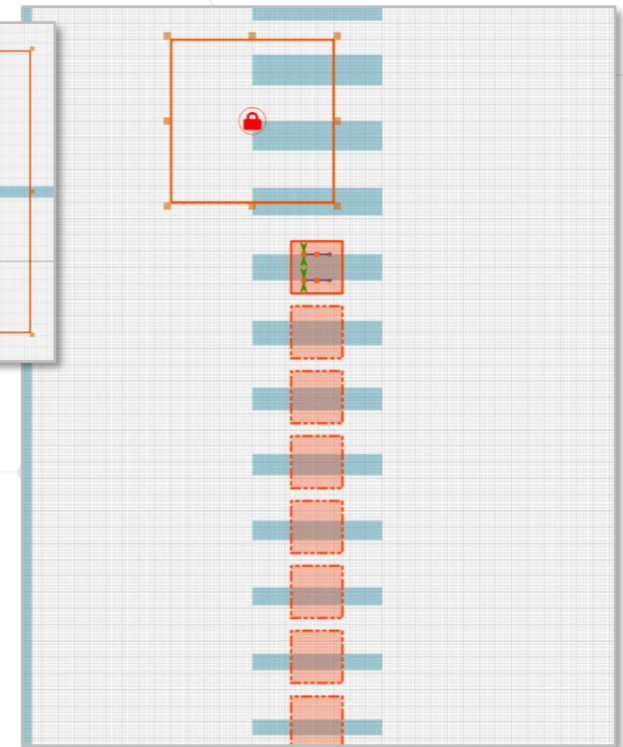
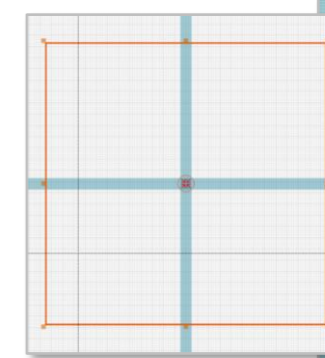
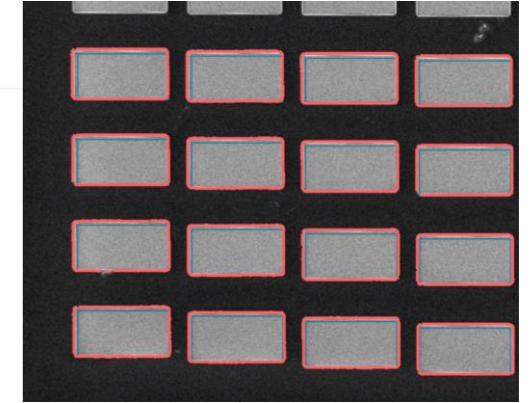
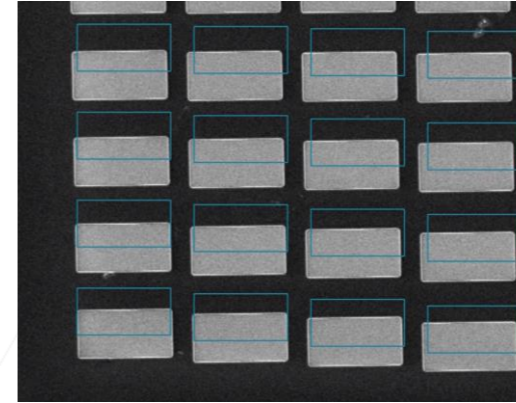
Mode:  Inverse Distance  
 Plane  
 Focus Interpolation During Job F  
 Multilevel B-Spline Low Curvature  
 Interpolate Stigmators  
 Multilevel B-Spline High Curvature  
 Focus Interpolation in Live Mode

→ Plane/ map for large area correction + local auto focus

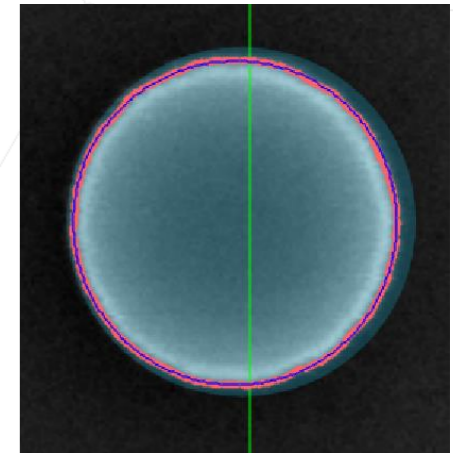
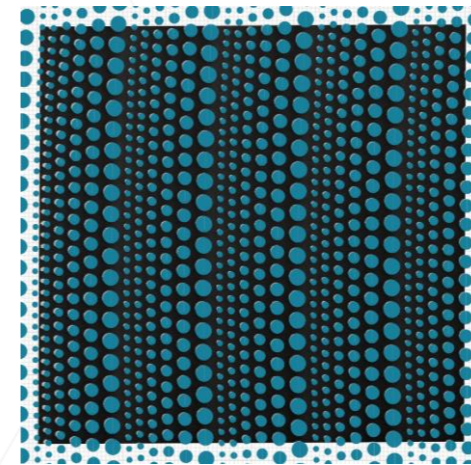
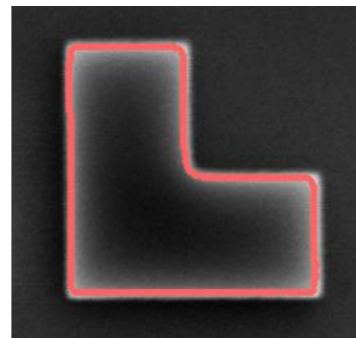
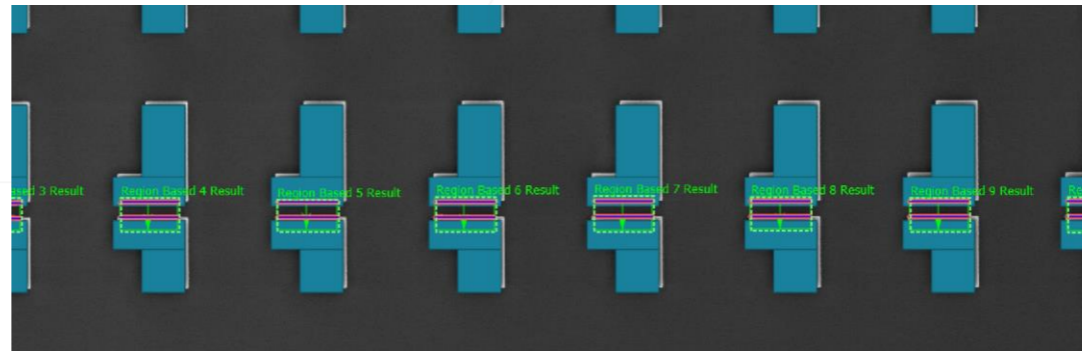
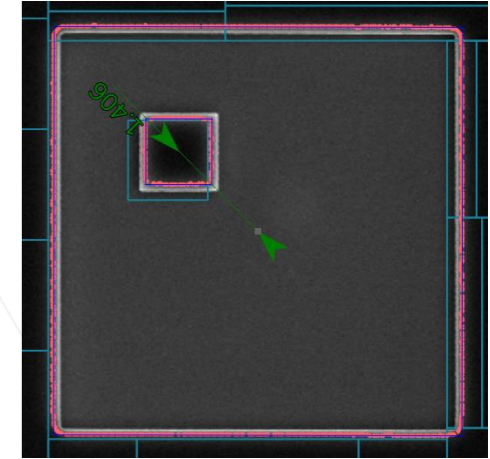
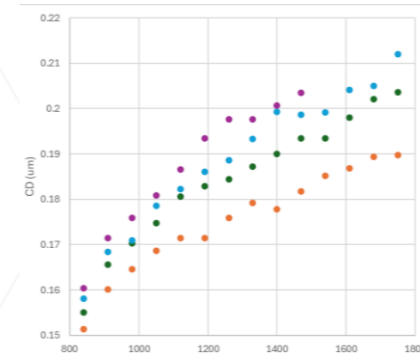
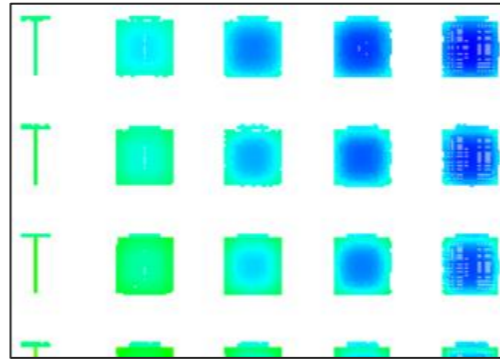
# Addressing SEM Challenges 2: Stage Position

## Limited accuracy in stage and sample positioning

- Individual image correction
  - Image-to-layout registration
- Local auto alignment for stage offset
  - Chip level: apply marker correction to general alignment
  - Local stage drives and scans
  - Alternatively: stage locked and scans within column range
- Compensation for stage/ sample drift
  - Automatic registration at marker or feature



- Resist calibration
- Placement analysis
- Device and pattern CD
- Contours with PV band
- Corner rounding/ blur
- Layout comparison/ bias



## InSPEC sessions during EIPBN

- Thursday morning: Session 3C Industrial Highlights
- Friday 12am – 1.30pm: Luncheon Workshop SEM Metrology → *Registration*
- Friday after lunch: Session 8A Chad Eichfeld, PSU

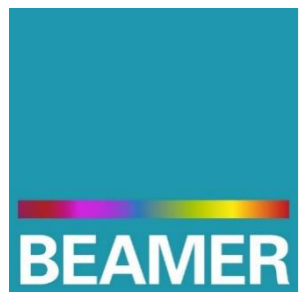


## THANKS to

- PSU: Chad Eichfeld, Bangzhi Liu, Michael Labella  
for our great pilot cooperation
- Kevin Lister for support and inspiring discussions
- GenISys MIS and US team

# Thank You!

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